Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Not For New Designs
Core Processor	M16C/60
Core Size	16-Bit
Speed	20MHz
Connectivity	I²C, IEBus, SIO, UART/USART
Peripherals	DMA, POR, PWM, Voltage Detect, WDT
Number of I/O	71
Program Memory Size	96KB (96K x 8)
Program Memory Type	FLASH
EEPROM Size	4K x 8
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 24x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	80-LQFP
Supplier Device Package	80-LQFP (12x12)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/m30280fahp-u7b

Notice

1. All information included in this document is current as of the date this document is issued. Such information, however, is subject to change without any prior notice. Before purchasing or using any Renesas Electronics products listed herein, please confirm the latest product information with a Renesas Electronics sales office. Also, please pay regular and careful attention to additional and different information to be disclosed by Renesas Electronics such as that disclosed through our website.
2. Renesas Electronics does not assume any liability for infringement of patents, copyrights, or other intellectual property rights of third parties by or arising from the use of Renesas Electronics products or technical information described in this document. No license, express, implied or otherwise, is granted hereby under any patents, copyrights or other intellectual property rights of Renesas Electronics or others.
3. You should not alter, modify, copy, or otherwise misappropriate any Renesas Electronics product, whether in whole or in part.
4. Descriptions of circuits, software and other related information in this document are provided only to illustrate the operation of semiconductor products and application examples. You are fully responsible for the incorporation of these circuits, software, and information in the design of your equipment. Renesas Electronics assumes no responsibility for any losses incurred by you or third parties arising from the use of these circuits, software, or information.
5. When exporting the products or technology described in this document, you should comply with the applicable export control laws and regulations and follow the procedures required by such laws and regulations. You should not use Renesas Electronics products or the technology described in this document for any purpose relating to military applications or use by the military, including but not limited to the development of weapons of mass destruction. Renesas Electronics products and technology may not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable domestic or foreign laws or regulations.
6. Renesas Electronics has used reasonable care in preparing the information included in this document, but Renesas Electronics does not warrant that such information is error free. Renesas Electronics assumes no liability whatsoever for any damages incurred by you resulting from errors in or omissions from the information included herein.
7. Renesas Electronics products are classified according to the following three quality grades: "Standard", "High Quality", and "Specific". The recommended applications for each Renesas Electronics product depends on the product's quality grade, as indicated below. You must check the quality grade of each Renesas Electronics product before using it in a particular application. You may not use any Renesas Electronics product for any application categorized as "Specific" without the prior written consent of Renesas Electronics. Further, you may not use any Renesas Electronics product for any application for which it is not intended without the prior written consent of Renesas Electronics. Renesas Electronics shall not be in any way liable for any damages or losses incurred by you or third parties arising from the use of any Renesas Electronics product for an application categorized as "Specific" or for which the product is not intended where you have failed to obtain the prior written consent of Renesas Electronics. The quality grade of each Renesas Electronics product is "Standard" unless otherwise expressly specified in a Renesas Electronics data sheets or data books, etc.

   "Standard": Computers; office equipment; communications equipment; test and measurement equipment; audio and visual equipment; home electronic appliances; machine tools; personal electronic equipment; and industrial robots.

   "High Quality": Transportation equipment (automobiles, trains, ships, etc.); traffic control systems; anti-disaster systems; anti-crime systems; safety equipment; and medical equipment not specifically designed for life support.

   "Specific": Aircraft; aerospace equipment; submersible repeaters; nuclear reactor control systems; medical equipment or systems for life support (e.g. artificial life support devices or systems), surgical implantations, or healthcare intervention (e.g. excision, etc.), and any other applications or purposes that pose a direct threat to human life.
8. You should use the Renesas Electronics products described in this document within the range specified by Renesas Electronics, especially with respect to the maximum rating, operating supply voltage range, movement power voltage range, heat radiation characteristics, installation and other product characteristics. Renesas Electronics shall have no liability for malfunctions or damages arising out of the use of Renesas Electronics products beyond such specified ranges.
9. Although Renesas Electronics endeavors to improve the quality and reliability of its products, semiconductor products have specific characteristics such as the occurrence of failure at a certain rate and malfunctions under certain use conditions. Further, Renesas Electronics products are not subject to radiation resistance design. Please be sure to implement safety measures to guard them against the possibility of physical injury, and injury or damage caused by fire in the event of the failure of a Renesas Electronics product, such as safety design for hardware and software including but not limited to redundancy, fire control and malfunction prevention, appropriate treatment for aging degradation or any other appropriate measures. Because the evaluation of microcomputer software alone is very difficult, please evaluate the safety of the final products or system manufactured by you.
10. Please contact a Renesas Electronics sales office for details as to environmental matters such as the environmental compatibility of each Renesas Electronics product. Please use Renesas Electronics products in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. Renesas Electronics assumes no liability for damages or losses occurring as a result of your noncompliance with applicable laws and regulations.
11. This document may not be reproduced or duplicated, in any form, in whole or in part, without prior written consent of Renesas Electronics.
12. Please contact a Renesas Electronics sales office if you have any questions regarding the information contained in this document or Renesas Electronics products, or if you have any other inquiries.

(Note 1) "Renesas Electronics" as used in this document means Renesas Electronics Corporation and also includes its majority-owned subsidiaries.

(Note 2) "Renesas Electronics product(s)" means any product developed or manufactured by or for Renesas Electronics.

REJ03B0201-0050
Rev.0.50
2006.09.15

1. Overview

The M16C/28 Group (M16C/28 and M16C/28B) MCU are single-chip control MCU, fabricated using high-performance silicon gate CMOS technology with the M16C/60 series CPU core. The M16C/28 Group (M16C/28 and M16C/28B) are housed in 64-pin and 80-pin plastic molded LQFP packages and also in 85-pin plastic molded TFLGA (Thin Fine Pitch Land Grid Array) package. With a 1-Mbyte address space, this MCU combines advanced instruction manipulation capabilities to process complex instructions by less bytes and execute instructions at higher speed. It includes a multiplier and DMAC adequate for office automation, communication devices and other high-speed processing applications.

The M16C/28 has Normal-ver., T-ver., and V-ver.. The M16C/28B has Normal-ver. only.

This hardware manual describes the Normal-ver. only. Please contact Renesas Technology Corp. for T-ver./V-ver. information.

1.1 Applications

Audio, cameras, office equipment, communication equipment, portable equipment, home appliances (in-verter solution), motor control, industrial equipment, etc.

Table 1.2 M16C/28 Group (M16C/28, M16C/28) (64-Pin Package)

	Item	Performance
CPU	Number of basic instructions	91 instructions
	Minimum instruction excution time	41.7 ns (f(BCLK) = 24 MHZ, VCC = 4.2 V to 5.5 V) (M16C/28B) 50 ns (f(BCLK) = 20 MHZ, VCC = 3.0V to 5.5V) (M16C/28, M16C/28B) 100 ns (f(BCLK) = 10 MHZ, VCC = 2.7V to 5.5V) (M16C/28, M16C/28B)
	Operation mode	Single chip mode
	Address space	1M bytes
	Memory capacity	See **Table 1.3**
Peripheral Function	I/O Port	Input/Output : 55 lines
	Multifunction timer	TimerA:16 bits x 5 channels, TimerB:16 bits x 3 channels Three-phase Motor Control Timer TimerS (Input Capture/Output Compare) : 16bit base timer x 1 channel (Input/Output x 8 channels)
	Serial I/O	2 channels (UART0, UART1) UART, clock synchronous 1 channel (UART2) UART, clock synchronous, I^2C bus(1), or IEbus(2) 1 channels (SI/O3, SI/O4) Clock synchronous 1 channel (Multi-Master I^2C bus(1))
	A/D converter	10 bits x 13 channels
	DMAC	2 channels
	Watchdog timer	15 bits x 1 (with prescaler)
	Interrupt	24 internal and 8 external sources, 4 software sources, 7 levels
	Clock generation circuit	4 circuits • Main clock(*) • Sub-clock(*) • On-chip oscillator • PLL frequency synthesizer (*) Equipped with a built-in feedback resistor
	Oscillation Stop Detect Function	Main clock oscillation stop, re-oscillation detect function
	Voltage detection circuit	Available
Electrical Characteristics	Power supply voltage	Vcc = 4.2 V to 5.5 V (f(BCLK) = 24 MHz) (M16C/28) Vcc = 3.0 V to 5.5 V (f(BCLK) = 20 MHz) (M16C/28, M16C/28B) Vcc = 2.7 V to 5.5 V (f(BCLK) = 10 MHz) (M16C/28, M16C/28B)
	Power consumption	16 mA (Vcc = 5 V, f(BCLK) = 20 MHz) 25 µA (f(XCIN) = 32 KHz on RAM) 3.0 µA (Vcc = 3 V, f(XCIN) = 32 KHz, in wait mode) 0.7 µA (Vcc = 3 V, in stop mode)
Flash Memory	Program/erase supply voltage	2.7 V to 5.5 V
	Program and erase endurance	100 times (all space) or 1,000 times (Blocks 0 to 5) /10,000 times (Block A, Block B(3))
Operating Ambient Temperature		-20 to 85C°/-40 to 85C°(3)
Package		64-pin plastic mold LQFP

NOTES:
1. I^2C bus is a trademark of Koninklijke Philips Electronics N. V.
2. IEBus is a trademark of NEC Electronics Corporation.
3. Refer to **Table 1.5** to **1.7** for number of program/erase.
4. Use PLL frequency synthesizer to use M16C/28B at f(BCLK) = 24 MHz.

1.3 Block Diagram

Figure 1.1 is a block diagram of the M16C/28 Group (M16C/28, M16C/28B), 80-pin and 85-pin package.
Figure 1.2 is a block diagram of the M16C/28 Group (M16C/28, M16C/28B), 64-pin package.

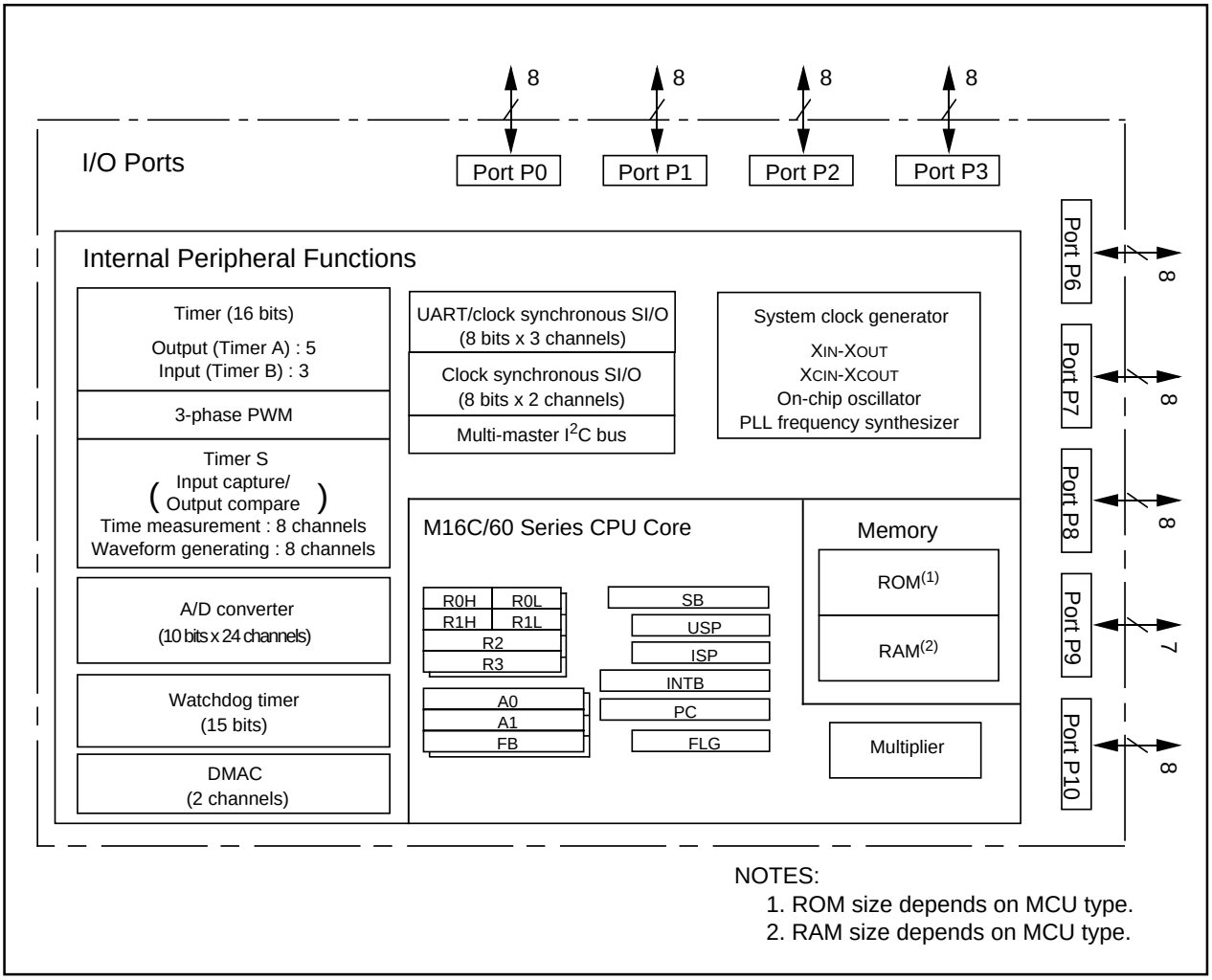


Figure 1.1 M16C/28 Group (M16C/28, M16C/28B), 80-Pin/85-Pin Block Diagram

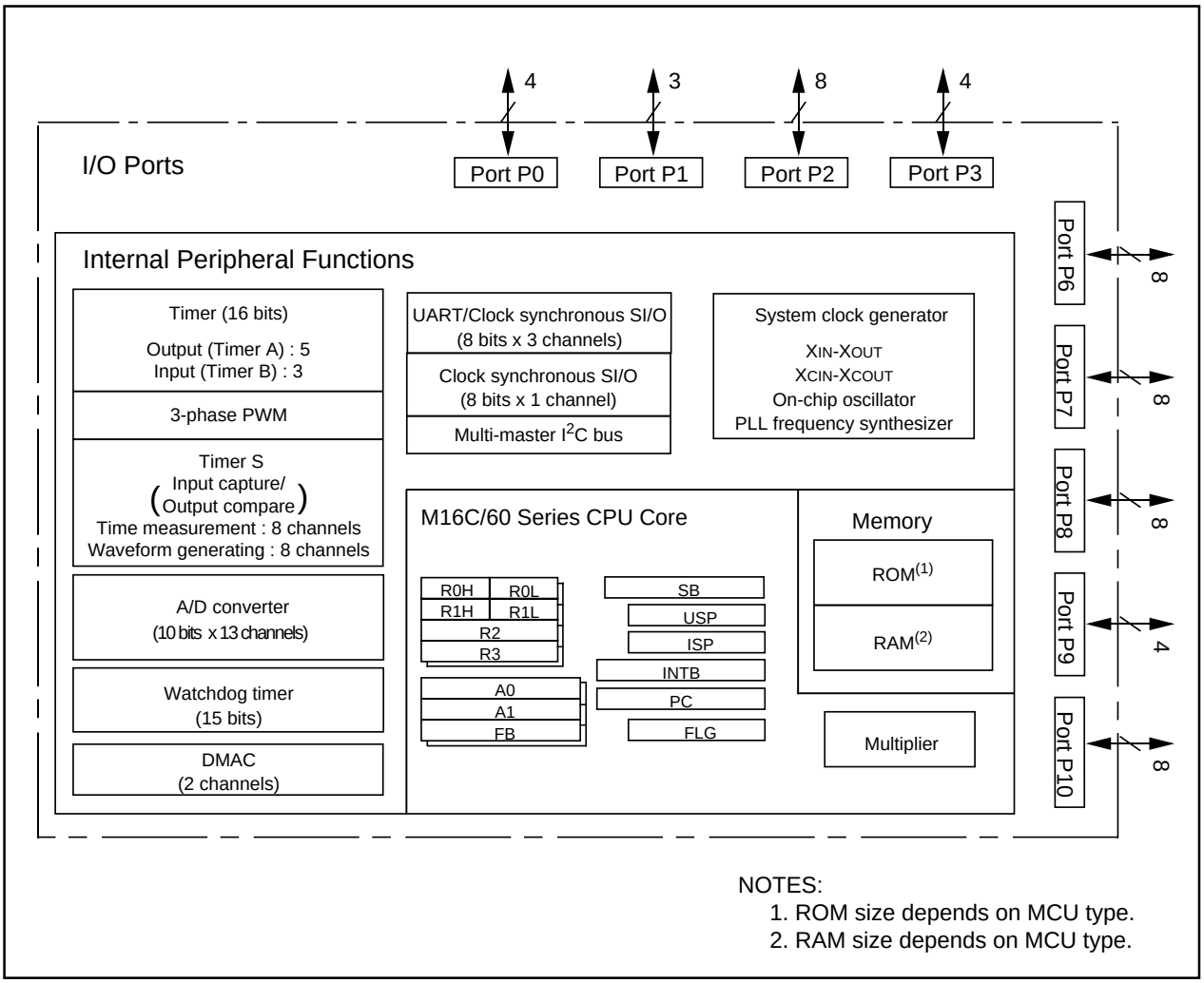


Figure 1.2 M16C/28 Group (M16C/28, M16C/28B), 64-Pin Block Diagram

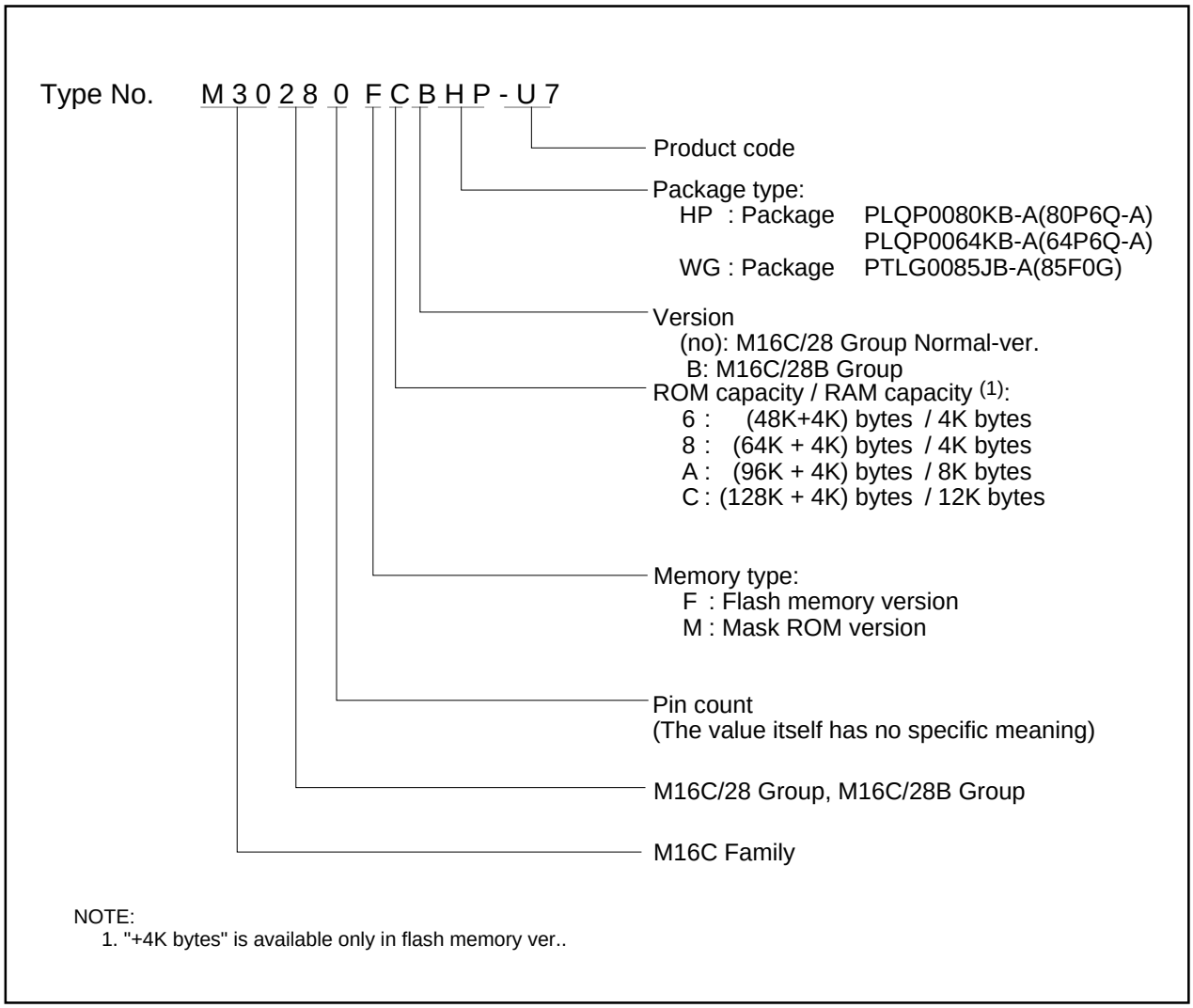


Figure 1.3 Product Numbering System

Table 1.5 Product Code (Flash Memory-ver.) - M16C/28 Normal-ver., 64-Pin(1)/80-Pin(1)/85-Pin Package

Product Code	Package	Internal ROM (User Program Space)		Internal ROM (Data Space)		Operating Ambient Temperature
		Program and Erase Endurance	Temperature Range	Program and Erase Endurance	Temperature Range	
U3	Lead free	100	0 to 60°C	100	0 to 60°C	-40 to 85°C
U5						-20 to 85°C
U7		1,000		10,000	-40 to 85°C	-40 to 85°C
U9					-20 to 85°C	-20 to 85°C

NOTE:
1. The lead contained products, D3, D5, D7 and D9, are put together with U3, U5, U7 and U9 respectively. Lead-free (Sn-Ag-Cu plating) products can be mounted by both conventional Sn-Pb paste and Lead-free paste.

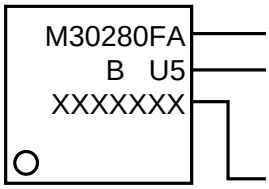
Table 1.6 Product Code (Flash Memory-ver.) - M16C/28B Normal-ver., 64-Pin/85-Pin Package

Product Code	Package	Internal ROM (User Program Space)		Internal ROM (Data Space)		Operating Ambient Temperature
		Program and Erase Endurance	Temperature Range	Program and Erase Endurance	Temperature Range	
U7	Lead-free	1,000	0 to 60°C	10,000	-40 to 85°C	-40 to 85°C

Table 1.7 Product Code (Mask ROM ver.) - M16C/28B Normal-ver., 64-Pin/80-Pin/85-Pin Package

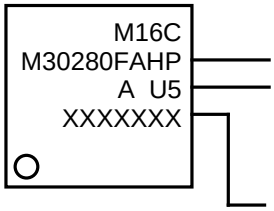
Product Code	Package	Operating Ambient Temperature
U3	Lead-free	-40 to 85°C
U5		-20 to 85°C

(1) Flash Memory Version, PTLG0085JB-A (85F0G), Normal-ver.



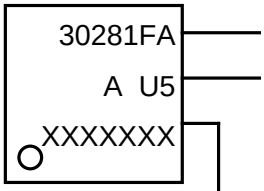
Type No. M30280FAWG
Chip version and product code
B : Chip version.
The first edition is shown to be blank and continues with A, B, and C.
U5 : Product code. (See **Table 1.5**)
Date code seven digits
Manufacturing management code

(2) Flash Memory Version, PLQP0080KB-A (80P6Q-A), Normal-ver.



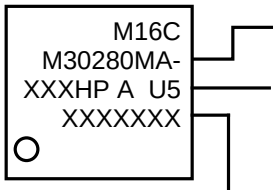
Type No. M30280FAHP
Chip version and product code
A : Chip version and product code(1)
The first edition is shown to be blank and continues with A, B and C.
U5 : Product code. (**Table 1.4**)
Date code seven digits
Manufacturing management code

(3) Flash Memory Version, PLQP0064KB-A (64P6Q-A), Normal-ver.



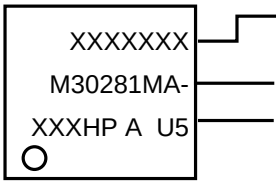
Type No. M30281FAHP
Chip version and product code
A : Chip version and product code(1)
The first edition is shown to be blank and continues with A, B and C.
U5 : Product code. (**Table 1.4**)
Date code seven digits
Manufacturing management code

(4) Mask ROM Version, PLQP0080KB-A (80P6Q-A), Normal-ver.



Type No. M30280MAHP
Chip version and product code
XXX : ROM No.
A : Chip version and product code(1)
The first edition is shown to be blank and continues with A, B and C.
U5 : Product code. (**Table 1.6**)
Date code seven digits
Manufacturing management code

(5) Mask ROM Version, PLQP0064-KB-A (64P6Q-A), Normal-ver.



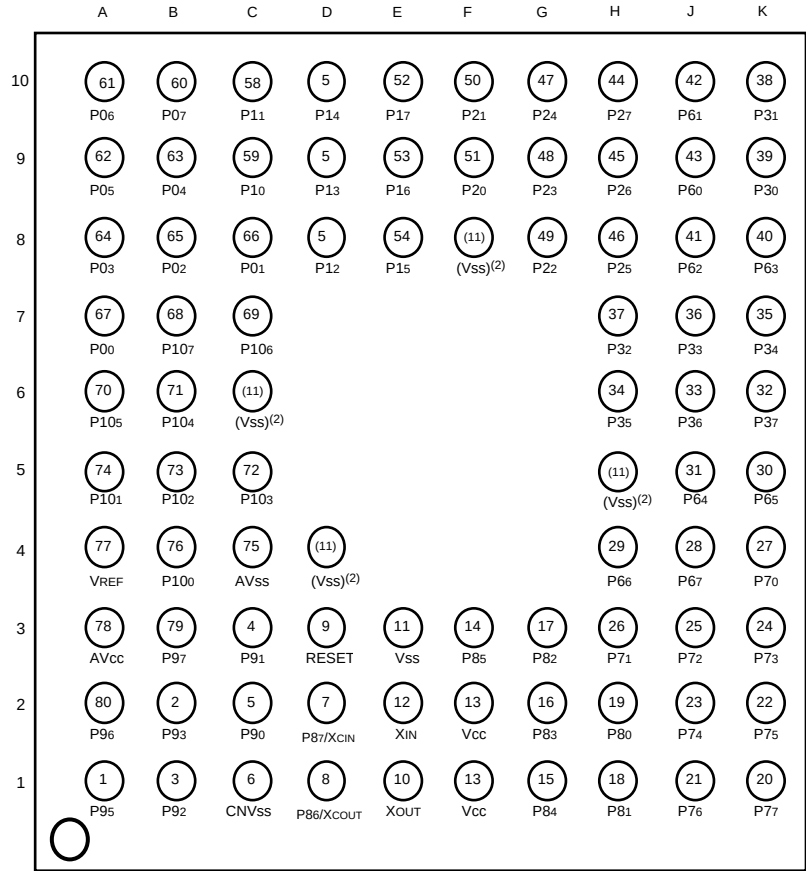
Date code seven digits
Manufacturing management code
Type No. M30281MAHP
Chip version and product code
XXX: ROM No.
A : Chip version and product code(1)
The first edition is shown to be blank and continues with A, B and C.
U5 : Product code. (**Table 1.6**)

NOTES:
1. The following functinos are not available in the first version and version A products.
-Delay trigger mode 0 of A/D conversion
-Delay trigger mode 1 of A/D conversion

Figure 1.4 Marking Diagram-M16C/28 Normal-ver.

1.5 Pin Assignment

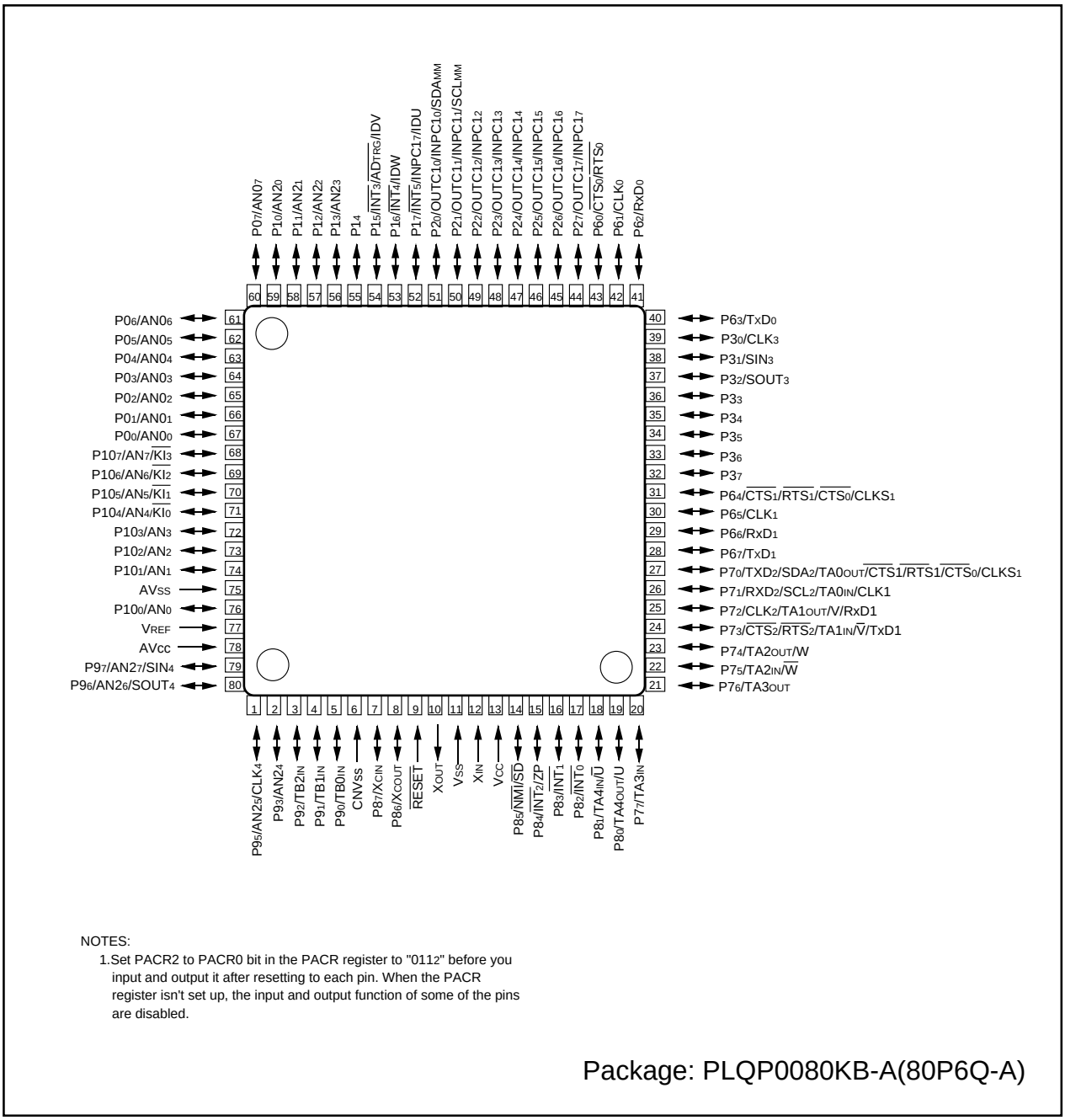
Figures 1.5 to 1.7 show the pin Assignments (top view).



NOTES :
1. The numbers in each grid (circle) show the pin numbers of the M30280FAHP (80P6Q-A package)
2. Connect grids written as (Vss) to Vss(GND) or leave them open.
3. Set PACR2 to PACR0 bits in the PACR register to "0112" before you input and output it after resetting to each pin. When the PACR register is not set, the input and output function of some pins are disabled.

Package: PTLG0085JB-A(85F0G)

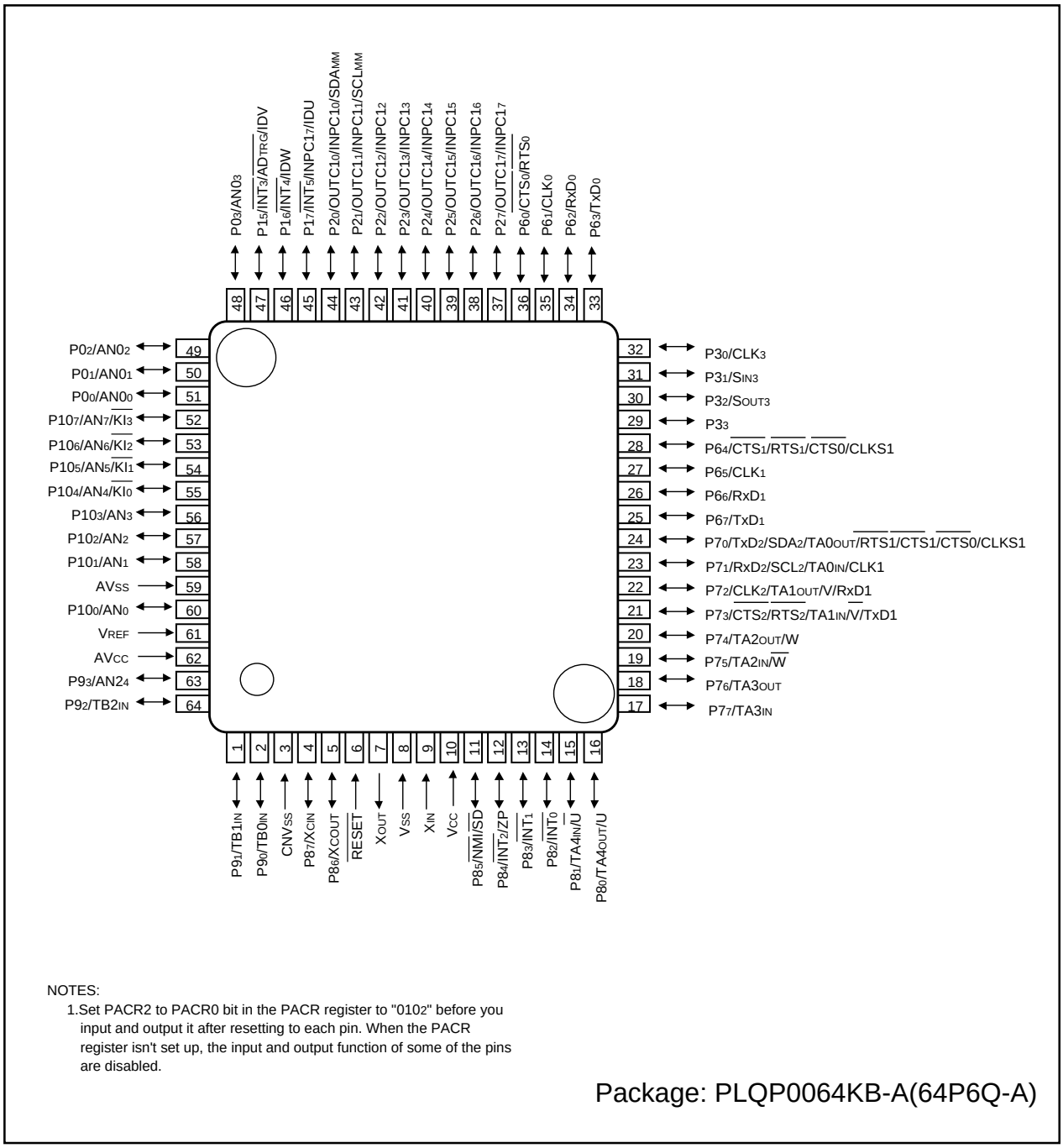
Figure 1.5 Pin Assignment (Top View) of 85-pin Package



NOTES:
1.Set PACR2 to PACR0 bit in the PACR register to "011₂" before you input and output it after resetting to each pin. When the PACR register isn't set up, the input and output function of some of the pins are disabled.

Package: PLQP0080KB-A(80P6Q-A)

Figure 1.5 Pin Assignment (Top View) of 80-Pin Package



NOTES:
1. Set PACR2 to PACR0 bit in the PACR register to "010₂" before you input and output it after resetting to each pin. When the PACR register isn't set up, the input and output function of some of the pins are disabled.

Package: PLQP0064KB-A(64P6Q-A)

Figure 1.6 Pin Assignment (Top View) of 64-Pin Package

Table 1.10 Pin Characteristics for 64-Pin Package

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	Timer S Pin	UART Pin	Mult-master I^2C bus Pin	Analog Pin
1		$P9_1$		TA_{1IN}				
2		$P9_0$		TB_{0IN}				
3	CNVss							
4	X_{CIN}	$P8_7$						
5	X_{COUT}	$P8_6$						
6	$\overline{RESET}$							
7	X_{OUT}							
8	Vss							
9	X_{IN}							
10	Vcc							
11		$P8_5$	$\overline{NMI}$	$\overline{SD}$				
12		$P8_4$	$\overline{INT_2}$	ZP				
13		$P8_3$	$\overline{INT_1}$					
14		$P8_2$	$\overline{INT_0}$					
15		$P8_1$		TA_{4IN} / $\overline{U}$				
16		$P8_0$		TA_{4OUT} / U				
17		$P7_7$		TA_{3IN}				
18		$P7_6$		TA_{3OUT}				
19		$P7_5$		TA_{2IN} / $\overline{W}$				
20		$P7_4$		TA_{2OUT} / W				
21		$P7_3$		TA_{1IN} / $\overline{V}$		$\overline{CTS_2}$ / $\overline{RTS_2}$ / TxD_1		
22		$P7_2$		TA_{1OUT} / V		CLK_2 / RxD_1		
23		$P7_1$		TA_{0IN}		RxD_2 / SCL_2 / CLK_1		
24		$P7_0$		TA_{0OUT}		TxD_2 / SDA_2 / $\overline{RTS_1}$ / $\overline{CTS_1}$ / $\overline{CTS_0}$ / $CLKS_1$		
25		$P6_7$				TxD_1		
26		$P6_6$				RxD_1		
27		$P6_5$				CLK_1		
28		$P6_4$				$\overline{RTS_1}$ / $\overline{CTS_1}$/ $\overline{CTS_0}$ / $CLKS_1$		
29		$P3_3$						
30		$P3_2$				$SOUT_3$		
31		$P3_1$				SIN_3		
32		$P3_0$				CLK_3		
33		$P6_3$				TxD_0		
34		$P6_2$				RxD_0		
35		$P6_1$				CLK_0		
36		$P6_0$				$\overline{RTS_0}$ / $\overline{CTS_0}$		
37		$P2_7$			$OUTC1_7$ / $INPC1_7$			
38		$P2_6$			$OUTC1_6$ / $INPC1_6$			
39		$P2_5$			$OUTC1_5$ / $INPC1_5$			
40		$P2_4$			$OUTC1_4$ / $INPC1_4$			

Table 10 Pin Characteristics for 64-Pin Package (Continued)

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	Timer S Pin	UART Pin	Multi-master I^2C bus Pin	Analog Pin
41		$P2_3$			$OUTC1_3$ / $INPC1_3$			
42		$P2_2$			$OUTC1_2$ / $INPC1_2$			
43		$P2_1$			$OUTC1_1$ / $INPC1_1$		SCL_{MM}	
44		$P2_0$			$OUTC1_0$ / $INPC1_0$		SDA_{MM}	
45		$P1_7$	$\overline{INT}_5$	IDU	$INPC1_7$			
46		$P1_6$	$\overline{INT}_4$	IDW				
47		$P1_5$	$\overline{INT}_3$	IDV				$\overline{AD_{TRG}}$
48		$P0_3$						$AN0_3$
49		$P0_2$						$AN0_2$
50		$P0_1$						$AN0_1$
51		$P0_0$						$AN0_0$
52		$P10_7$	$\overline{KI}_3$					AN_7
53		$P10_6$	$\overline{KI}_2$					AN_6
54		$P10_5$	$\overline{KI}_1$					AN_5
55		$P10_4$	$\overline{KI}_0$					AN_4
56		$P10_3$						AN_3
57		$P10_2$						AN_2
58		$P10_1$						AN_1
59	AVss							
60		$P10_0$						AN_0
61	V_{REF}							
62	AVcc							
63		$P9_3$						$AN2_4$
64		$P9_2$		TB_{2IN}				

Table 1.10 Pin Description (64-Pin, 80-Pin and 85-Pin Packages) (Continued)

Classification	Symbol	I/O Type	Function
Timer S	$INPC1_0$ to $INPC1_7$	I	Input pins for the time measurement function
	$OUTC1_0$ to $OUTC1_7$	O	Output pins for the waveform generating function
I/O Ports	$P0_0$ to $P0_3$ $P1_5$ to $P1_7$ $P2_0$ to $P2_7$ $P3_0$ to $P3_3$ $P6_0$ to $P6_7$ $P7_0$ to $P7_7$ $P8_0$ to $P8_7$ $P10_0$ to $P10_7$	I/O	I/O ports for CMOS. Each port can be programmed for input or output under the control of the direction register. An input port can be set, by program, for a pull-up resistor available or for no pull-up resister available in 4-bit units
	$P9_0$ to $P9_3$	I/O	I/O ports having equivalent functions to P0

I : Input O : Output I/O : Input and output

Table 1.10 Pin Description (80-Pin and 85-Pin Packages only) (Continued)

Classification	Symbol	I/O Type	Function
Serial I/O	CLK4	I/O	Inputs and outputs the transfer clock
	SIN4	I	Inputs serial data
	SOUT4	O	Outputs serial data
A/D Converter	AN04 to AN07 AN20 to AN23 AN25 to AN27	I	Analog input pins for the A/D converter
I/O Ports	P04 to P07 P10 to P14 P34 to P37	I/O	I/O ports for CMOS. Each port can be programmed for input or output under the control of the direction register. An input port can be set, by program, for a pull-up resistor available or for no pull-up resister available in 4-bit units
	P95 to P97	I/O	I/O ports having equivalent functions to P0

I : Input O : Output I/O : Input and output

2.3 Frame Base Register (FB)

FB is configured with 16 bits, and is used for FB relative addressing.

2.4 Interrupt Table Register (INTB)

INTB is configured with 20 bits, indicating the start address of an interrupt vector table.

2.5 Program Counter (PC)

PC is configured with 20 bits, indicating the address of an instruction to be executed.

2.6 User Stack Pointer (USP) and Interrupt Stack Pointer (ISP)

Stack pointer (SP) comes in two types: USP and ISP, each configured with 16 bits.

Your desired type of stack pointer (USP or ISP) can be selected by the U flag of FLG.

2.7 Static Base Register (SB)

SB is configured with 16 bits, and is used for SB relative addressing.

2.8 Flag Register (FLG)

FLG consists of 11 bits, indicating the CPU status.

2.8.1 Carry Flag (C Flag)

This flag retains a carry, borrow, or shift-out bit that has occurred in the arithmetic/logic unit.

2.8.2 Debug Flag (D Flag)

The D flag is used exclusively for debugging purpose. During normal use, it must be set to 0.

2.8.3 Zero Flag (Z Flag)

This flag is set to 1 when an arithmetic operation resulted in 0; otherwise, it is 0.

2.8.4 Sign Flag (S Flag)

This flag is set to 1 when an arithmetic operation resulted in a negative value; otherwise, it is 0.

2.8.5 Register Bank Select Flag (B Flag)

Register bank 0 is selected when this flag is 0 ; register bank 1 is selected when this flag is 1.

2.8.6 Overflow Flag (O Flag)

This flag is set to 1 when the operation resulted in an overflow; otherwise, it is 0.

2.8.7 Interrupt Enable Flag (I Flag)

This flag enables a maskable interrupt.

Maskable interrupts are disabled when the I flag is 0, and are enabled when the I flag is 1. The I flag is cleared to 0 when the interrupt request is accepted.

2.8.8 Stack Pointer Select Flag (U Flag)

ISP is selected when the U flag is 0; USP is selected when the U flag is 1.

The U flag is cleared to 0 when a hardware interrupt request is accepted or an INT instruction for software interrupt Nos. 0 to 31 is executed.

2.8.9 Processor Interrupt Priority Level (IPL)

IPL is configured with three bits, for specification of up to eight processor interrupt priority levels from level 0 to level 7.

If a requested interrupt has priority greater than IPL, the interrupt is enabled.

2.8.10 Reserved Area

When write to this bit, write 0. When read, its content is indeterminate.

3. Memory

Figure 3.1 is a memory map of the M16C/28 Group (M16C/28, M16C/28B). M16C/28 Group provides 1-Mbyte address space from addresses 00000$_{16}$ to FFFFF$_{16}$. The internal ROM is allocated lower addresses beginning with address FFFFF$_{16}$. For example, 64 Kbytes internal ROM is allocated addresses F0000$_{16}$ to FFFFF$_{16}$.

Two 2-Kbyte internal ROM areas, block A and block B, are available in the flash memory version. The blocks are allocated addresses F000$_{16}$ to FFFF$_{16}$.

The fixed interrupt vector tables are allocated addresses FFFDC$_{16}$ to FFFFF$_{16}$. It stores the starting address of each interrupt routine. See the section on interrupts for details.

The internal RAM is allocated higher addresses beginning with address 00400$_{16}$. For example, 4-Kbytes internal RAM is allocated addresses 00400$_{16}$ to 013FF$_{16}$. Besides storing data, it becomes stacks when the subroutine is called or an interrupt is acknowledged.

SFR, consisting of control registers for peripheral functions such as I/O port, A/D converter, serial I/O, timers is allocated addresses 00000$_{16}$ to 003FF$_{16}$. All blank spaces within SFR are reserved and cannot be accessed by users.

The special page vector table is allocated to the addresses FFE00$_{16}$ to FFFDB$_{16}$. This vector is used by the JMPS or JSRS instruction. For details, refer to the ***M16C/60 and M16C/20 Series Software Manual***.

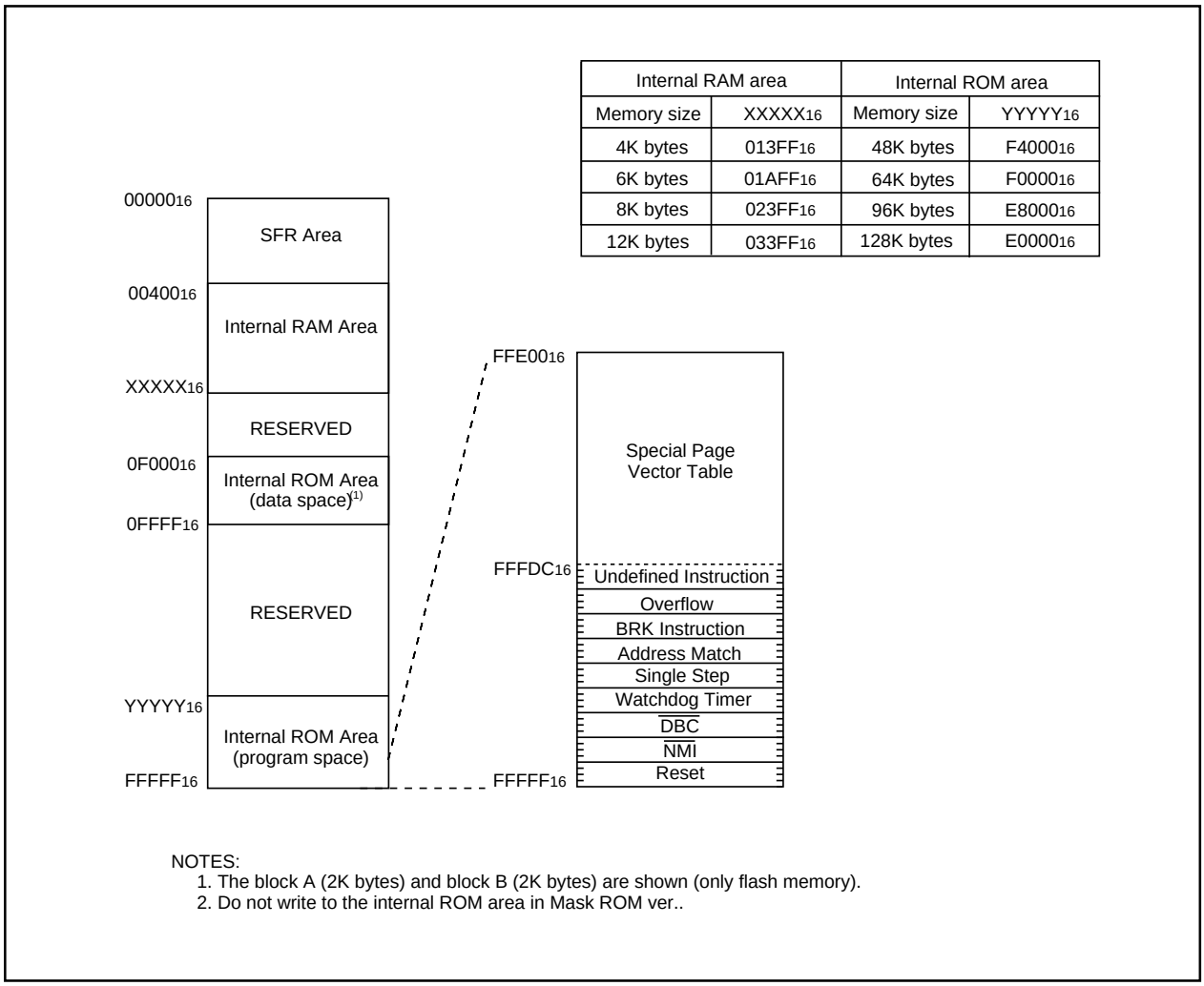


Figure 3.1 Memory Map

Table 4.4 SFR Information(4)(1)

Address	Register	Symbol	After Reset
0300₁₆	TM, WG register 0	G1TM0, G1PO0	XX₁₆
0301₁₆			XX₁₆
0302₁₆	TM, WG register 1	G1TM1, G1PO1	XX₁₆
0303₁₆			XX₁₆
0304₁₆	TM, WG register 2	G1TM2, G1PO2	XX₁₆
0305₁₆			XX₁₆
0306₁₆	TM, WG register 3	G1TM3, G1PO3	XX₁₆
0307₁₆			XX₁₆
0308₁₆	TM, WG register 4	G1TM4, G1PO4	XX₁₆
0309₁₆			XX₁₆
030A₁₆	TM, WG register 5	G1TM5, G1PO5	XX₁₆
030B₁₆			XX₁₆
030C₁₆	TM, WG register 6	G1TM6, G1PO6	XX₁₆
030D₁₆			XX₁₆
030E₁₆	TM, WG register 7	G1TM7, G1PO7	XX₁₆
030F₁₆			XX₁₆
0310₁₆	WG control register 0	G1POCR0	0X00XX00₂
0311₁₆	WG control register 1	G1POCR1	0X00XX00₂
0312₁₆	WG control register 2	G1POCR2	0X00XX00₂
0313₁₆	WG control register 3	G1POCR3	0X00XX00₂
0314₁₆	WG control register 4	G1POCR4	0X00XX00₂
0315₁₆	WG control register 5	G1POCR5	0X00XX00₂
0316₁₆	WG control register 6	G1POCR6	0X00XX00₂
0317₁₆	WG control register 7	G1POCR7	0X00XX00₂
0318₁₆	TM control register 0	G1TMCR0	00₁₆
0319₁₆	TM control register 1	G1TMCR1	00₁₆
031A₁₆	TM control register 2	G1TMCR2	00₁₆
031B₁₆	TM control register 3	G1TMCR3	00₁₆
031C₁₆	TM control register 4	G1TMCR4	00₁₆
031D₁₆	TM control register 5	G1TMCR5	00₁₆
031E₁₆	TM control register 6	G1TMCR6	00₁₆
031F₁₆	TM control register 7	G1TMCR7	00₁₆
0320₁₆	Base timer register	G1BT	XX₁₆
0321₁₆			XX₁₆
0322₁₆	Base timer control register 0	G1BCR0	00₁₆
0323₁₆	Base timer control register 1	G1BCR1	00₁₆
0324₁₆	TM prescale register 6	G1TPR6	00₁₆
0325₁₆	TM prescale register 7	G1TPR7	00₁₆
0326₁₆	Function enable register	G1FE	00₁₆
0327₁₆	Function select register	G1FS	00₁₆
0328₁₆	Base timer reset register	G1BTRR	XX₁₆
0329₁₆			XX₁₆
032A₁₆	Divider register	G1DV	00₁₆
032B₁₆			
032C₁₆			
032D₁₆			
032E₁₆			
032F₁₆			
0330₁₆	Interrupt request register	G1IR	XX₁₆
0331₁₆	Interrupt enable register 0	G1IE0	00₁₆
0332₁₆	Interrupt enable register 1	G1IE1	00₁₆
0333₁₆			
0334₁₆			
0335₁₆			
0336₁₆			
0337₁₆			
0338₁₆			
0339₁₆			
033A₁₆			
033B₁₆			
033C₁₆			
033D₁₆			
033E₁₆	NMI digital debounce register	NDDR	FF₁₆
033F₁₆	P17 digital debounce register	P17DDR	FF₁₆

Note 1:The blank spaces are reserved. No access is allowed.

X : Undefined

Table 4.7 SFR Information(7)(1)

Address	Register	Symbol	After Reset
03C0₁₆	A/D register 0	AD0	XX16
03C1₁₆			XX16
03C2₁₆	A/D register 1	AD1	XX16
03C3₁₆			XX16
03C4₁₆	A/D register 2	AD2	XX16
03C5₁₆			XX16
03C6₁₆	A/D register 3	AD3	XX16
03C7₁₆			XX16
03C8₁₆	A/D register 4	AD4	XX16
03C9₁₆			XX16
03CA₁₆	A/D register 5	AD5	XX16
03CB₁₆			XX16
03CC₁₆	A/D register 6	AD6	XX16
03CD₁₆			XX16
03CE₁₆	A/D register 7	AD7	XX16
03CF₁₆			XX16
03D0₁₆			
03D1₁₆			
03D2₁₆	A/D trigger control register	ADTRGCON	0016
03D3₁₆	A/D convert status register 0	ADSTAT0	00000X002
03D4₁₆	A/D control register 2	ADCON2	0016
03D5₁₆			
03D6₁₆	A/D control register 0	ADCON0	00000XXX2
03D7₁₆	A/D control register 1	ADCON1	0016
03D8₁₆			
03D9₁₆			
03DA₁₆			
03DB₁₆			
03DC₁₆			
03DD₁₆			
03DE₁₆			
03DF₁₆			
03E0₁₆	Port P0 register	P0	XX16
03E1₁₆	Port P1 register	P1	XX16
03E2₁₆	Port P0 direction register	PD0	0016
03E3₁₆	Port P1 direction register	PD1	0016
03E4₁₆	Port P2 register	P2	XX16
03E5₁₆	Port P3 register	P3	XX16
03E6₁₆	Port P2 direction register	PD2	0016
03E7₁₆	Port P3 direction register	PD3	0016
03E8₁₆			
03E9₁₆			
03EA₁₆			
03EB₁₆			
03EC₁₆	Port P6 register	P6	XX16
03ED₁₆	Port P7 register	P7	XX16
03EE₁₆	Port P6 direction register	PD6	0016
03EF₁₆	Port P7 direction register	PD7	0016
03F0₁₆	Port P8 register	P8	XX16
03F1₁₆	Port P9 register	P9	XX16
03F2₁₆	Port P8 direction register	PD8	0016
03F3₁₆	Port P9 direction register	PD9	000X00002
03F4₁₆	Port P10 register	P10	XX16
03F5₁₆			
03F6₁₆	Port P10 direction register	PD10	0016
03F7₁₆			
03F8₁₆			
03F9₁₆			
03FA₁₆			
03FB₁₆			
03FC₁₆	Pull-up control register 0	PUR0	0016
03FD₁₆	Pull-up control register 1	PUR1	0016
03FE₁₆	Pull-up control register 2	PUR2	0016
03FF₁₆	Port control register	PCR	0016

Note 1:The blank spaces are reserved. No access is allowed.

X : Undefined

REVISION HISTORY	M16C/28 Group (M16C/28, M16C/28B) Shortsheet

Rev.	Date	Description	
		Page	Summary
0.50	09/15/06	-	First edition